LNJ247W82RA

Hight Bright Surface Mounting Chip LED

1005 Type

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit | | | | | |
|-------------------------------|------------------|-------------|------|--|--|--|--|--|
| Power dissipation | P_{D} | 55 | mW | | | | | |
| Forward current | I_{F} | 20 | mA | | | | | |
| Pulse forward current * | I_{FP} | 60 | mA | | | | | |
| Reverse voltage | V _R | 4 | V | | | | | |
| Operating ambient temperature | T _{opr} | -30 to +85 | °C | | | | | |
| Storage temperature | T _{stg} | -40 to +100 | °C | | | | | |

■ Lighting Color

• Red

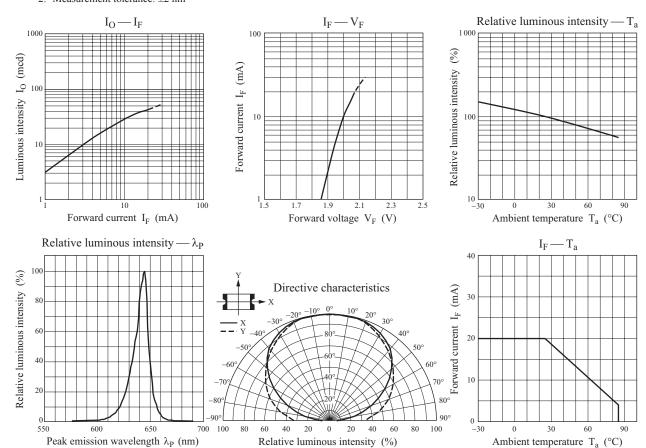
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

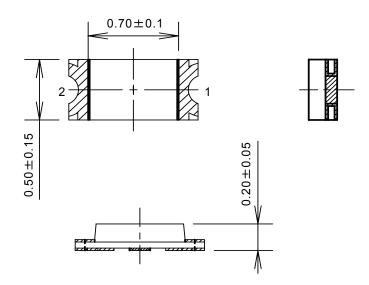
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------------------|------------------------|----------------------|-----|------|------|------|
| Luminous intensity *1 | I _O | $I_F = 5 \text{ mA}$ | 5.8 | 16.0 | 26.8 | mcd |
| Reverse current | I_R | $V_R = 4 V$ | | | 100 | μΑ |
| Forward voltage | V _F | $I_F = 5 \text{ mA}$ | | 1.95 | 2.30 | V |
| Peak emission wavelength | λ_{P} | $I_F = 5 \text{ mA}$ | | 645 | | nm |
| Dominant emission wavelength *2 | λ_{d} | $I_F = 5 \text{ mA}$ | 620 | 630 | 640 | nm |
| Spectral half band width | Δλ | $I_F = 5 \text{ mA}$ | | 20 | | nm |

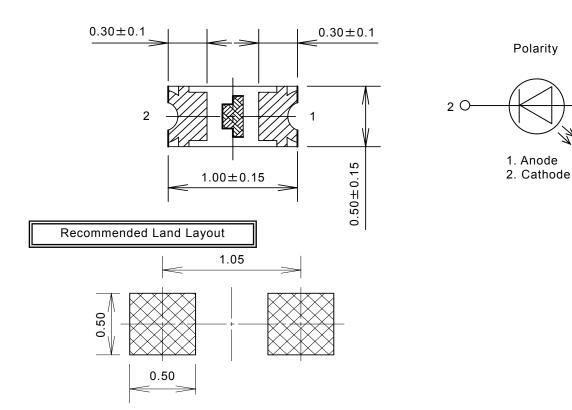
Note) *1: Measurement tolerance: ±20%

^{*2:} Measurement tolerance: ±2 nm



■ Package (Unit: mm)





(Note1)Electrode projection is not included in the package dimensions. (Note2)About solder thickness, please examine the products yourself completely. (Recommended thickness: $t=0.10 \, \text{mm} \sim 0.15 \, \text{mm}$)

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